

## Features

- ❑ 50 ns worst-case multiply time
- ❑ Low-power CMOS technology
- ❑ Replaces TRW MPY112K
- ❑ Two's complement or unsigned operands
- ❑ Three-state outputs
- ❑ Available screened to MIL-STD-883, Class B
- ❑ Package styles available:
  - 48-pin Plastic DIP
  - 48-pin Sidebrazed, Hermetic DIP

## Description

The LMU112 is a high-speed, low power, 12-bit parallel multiplier built using advanced CMOS technology. The LMU112 is pin and functionally compatible with TRW's MPY112K.

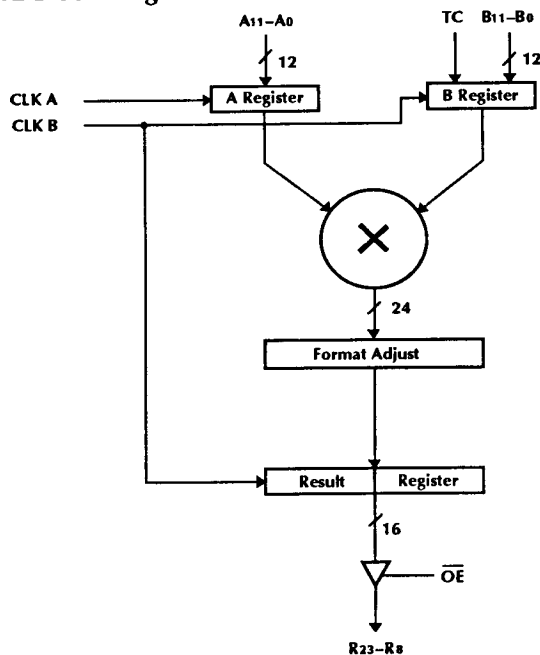
The A and B input operands are loaded into their respective registers on the rising edge of the separate clock inputs (CLK A and CLK B). Two's complement or unsigned magnitude operands are accommodated via the operand control bit, TC, which is loaded along with the B operands. The operands are specified

to be in two's complement format when TC is asserted and unsigned magnitude when TC is de-asserted. Mixed mode operation is not allowed.

For two's complement operands, the 17 most significant bits at the output of the asynchronous multiplier array are shifted one bit position to the left. This is done to discard the redundant copy of the sign-bit, which is in the most significant bit position, and extend the bit precision by one bit. The result is then truncated to the 16 MSB's and loaded into the output register on the rising edge of CLK B.

The contents of the output register are made available via three-state buffers by asserting  $\overline{OE}$ . When  $\overline{OE}$  is de-asserted, the outputs (R23-R8) are in the high impedance state.

LMU112 Block Diagram



# LOGIC

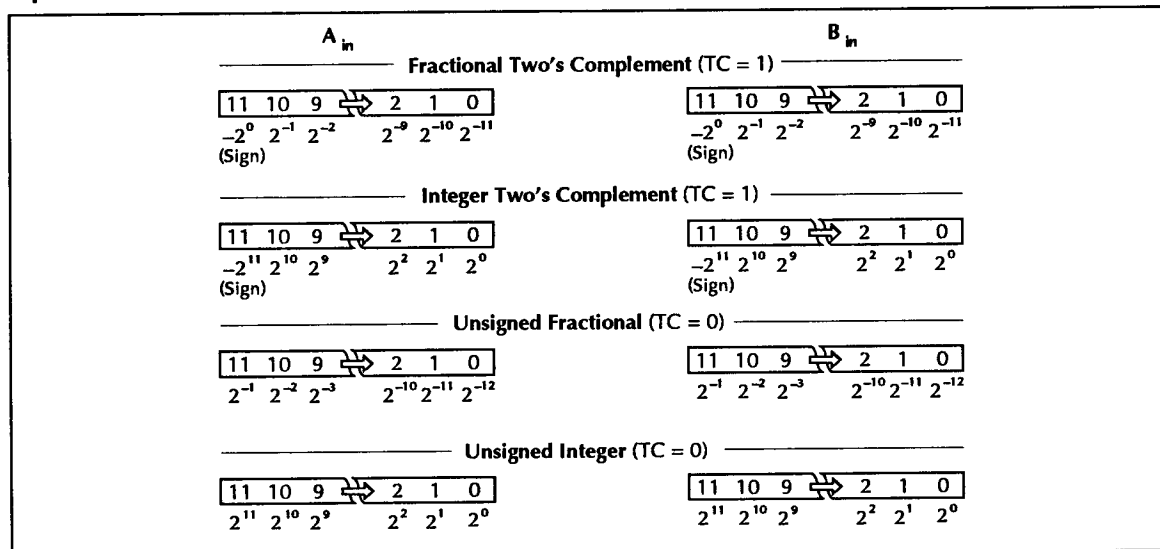
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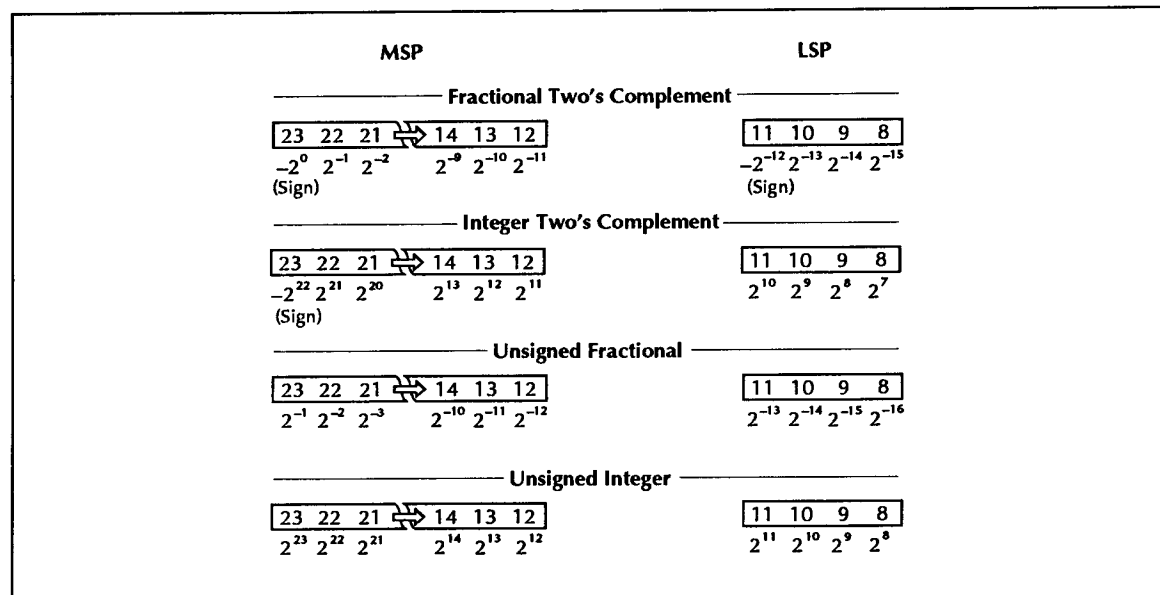
Logic Products

# 12 x 12-bit Parallel Multiplier

## Input Formats



## Output Formats



## Maximum Ratings

*Above which useful life may be impaired (Notes 1, 2, 3, 8)*

Storage temperature .....	–65°C to +150°C
Operating ambient temperature .....	–55°C to +125°C
VCC supply voltage with respect to ground .....	–0.5 V to +7.0 V
Input signal with respect to ground .....	–3.0 V to +7.0 V
Signal applied to high impedance output .....	–3.0 V to +7.0 V
Output current into low outputs .....	25 mA
Latchup current .....	> 400 mA

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## Operating Conditions

*To meet specified electrical and switching characteristics*

Mode	Temperature Range (Ambient)	Supply Voltage
Active Operation, Commercial	0°C to +70°C	4.75 V ≤ VCC ≤ 5.25 V
Active Operation, Military	–55°C to +125°C	4.50 V ≤ VCC ≤ 5.50 V

## Electrical Characteristics

*Over Operating Conditions*

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
VOH	Output High Voltage	IOH = –2.0 mA	3.5			V
VOL	Output Low Voltage	IOL = 8.0 mA			0.5	V
VIH	Input High Voltage		2.0		VCC	V
VIL	Input Low Voltage	Note 3	0.0		0.8	V
IIX	Input Current	Ground ≤ VI ≤ VCC			±20	μA
IOZ	Output Leakage Current	Ground ≤ VO ≤ VCC			±20	μA
IOS	Output Short Current	VO = Ground, VCC = Max, Note 4, 8			–250	mA
ICC1	VCC Current, Dynamic	Notes 5, 6		10	20	mA
ICC2	VCC Current, Quiescent	Note 7			1.0	mA

# 12 x 12-bit Parallel Multiplier

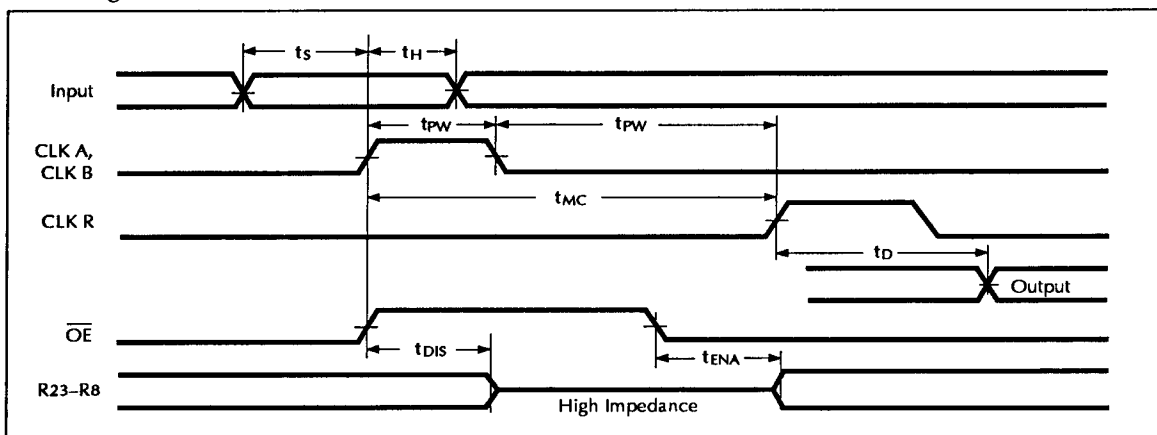
## Switching Characteristics Over Commercial Operating Range (Notes 9, 10) (ns)

Symbol      Parameter		LMU112-60		LMU112-50	
		Min	Max	Min	Max
t <sub>MC</sub>	Multiply Time (Clocked)		60		50
t <sub>D</sub>	Output Delay		25		25
t <sub>ENA</sub>	Output Enable Time (Note 11)		25		25
t <sub>DIS</sub>	Output Disable Time (Note 11)		25		25
t <sub>PW</sub>	Clock Pulse Width	15		15	
t <sub>H</sub>	Input Register Hold Time	0		0	
t <sub>S</sub>	Input Register Setup Time	15		15	

## Switching Characteristics Over Military Operating Range (Notes 9, 10) (ns)

Symbol      Parameter		LMU112-65		LMU112-55	
		Min	Max	Min	Max
t <sub>MC</sub>	Multiply Time (Clocked)		65		55
t <sub>D</sub>	Output Delay		30		30
t <sub>ENA</sub>	Output Enable Time (Note 11)		30		30
t <sub>DIS</sub>	Output Disable Time (Note 11)		30		30
t <sub>PW</sub>	Clock Pulse Width	20		20	
t <sub>H</sub>	Input Register Hold Time	0		0	
t <sub>S</sub>	Input Register Setup Time	15		15	

## Switching Waveforms



## Notes

1. Maximum Ratings indicate stress specifications only. Functional operation of these products at values beyond those indicated in the Operating Conditions table is not implied. Exposure to maximum rating conditions for extended periods may affect reliability.

2. The products described by this specification include internal circuitry designed to protect the chip from damaging substrate injection currents and accumulations of static charge. Nevertheless, conventional precautions should be observed during storage, handling, and use of these circuits in order to avoid exposure to excessive electrical stress values.

3. This device provides hard clamping of transient undershoot and overshoot. Input levels below ground or above VCC will be clamped beginning at -0.6 V and VCC + 0.6 V. The device can withstand indefinite operation with inputs in the range of -3.0 V to +7.0 V. Device operation will not be adversely affected, however, input current levels will be well in excess of 100 mA.

4. Duration of the output short circuit should not exceed 30 seconds.

5. Supply current for a given application can be accurately approximated by

$$\frac{NCV^2F}{4}$$

where

N = total number of device outputs

C = capacitive load per output

V = supply voltage

F = clock frequency

6. Tested with all outputs changing every cycle and no load, at a 5 MHz clock rate.

7. Tested with all inputs within 0.1 V of VCC or Ground, no load.

8. These parameters are guaranteed but not 100% tested.

9. AC specifications tested with input transition times less than 3 ns, output reference levels of 1.5 V (except tEN/tDIS test) and input levels of nominally 0 to 3.0 V. Output loading is a resistive divider which provides for specified IOL and IOH plus 30 pF capacitance.

This device has high speed outputs capable of large instantaneous current pulses and fast turn-on/turn-off times. As a result, care must be exercised in the testing of this device. The following measures are recommended:

a. A 0.1  $\mu$ F ceramic capacitor should be installed between VCC and Ground leads as close to the Device Under Test (DUT) as possible. Similar capacitors should be installed between device VCC and the tester common, and device ground and tester common.

b. Ground and VCC supply planes must be brought directly to the DUT socket or contactor fingers.

c. Input voltages should be adjusted to compensate for inductive ground and VCC noise to maintain required DUT input levels relative to the DUT ground pin.

10. Each parameter is shown as a minimum or maximum value. Input requirements are specified from the point of view of the external system driving the chip. Setup time, for example, is specified as a minimum since the external system must supply at least that much time to meet the worst-case requirements of all parts. Responses from the internal circuitry are specified from the point of view of the device. Output delay, for example, is specified as a maximum since worst-case operation of any device always provides data within that time.

11. Transition is measured  $\pm 200$  mV from steady-state voltage with specified loading.

# 12 x 12-bit Parallel Multiplier

## Ordering Information

### Commercial Operating Range (0°C to +70°C)

Package Style	Performance	
	60 ns	50 ns
48-pin Plastic DIP (0.6") — P5	LMU112PC60	LMU112PC50
48-pin Sidebrazed (0.6") Hermetic DIP — D5	LMU112DC60	LMU112DC50

### Military Operating Range (–55°C to +125°C)

Package Style	Performance	
	65 ns	55 ns
48-pin Sidebrazed (0.6") Hermetic DIP — D5	LMU112DM65 LMU112DME65 LMU112DMB65	LMU112DM55 LMU112DME55 LMU112DMB55

## Pin Assignments

Pin	Function	Pin	Function
1	A10	25	R18
2	A11	26	R17
3	B0	27	R16
4	B1	28	R15
5	B2	29	R14
6	B3	30	R13
7	B4	31	R12
8	B5	32	R11
9	B6	33	R10
10	B7	34	R9
11	B8	35	R8
12	VCC	36	GND
13	VCC	37	GND
14	B9	38	CLK A
15	B10	39	A0
16	B11	40	A1
17	TC	41	A2
18	CLK B	42	A3
19	OE	43	A4
20	R23	44	A5
21	R22	45	A6
22	R21	46	A7
23	R20	47	A8
24	R19	48	A9

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